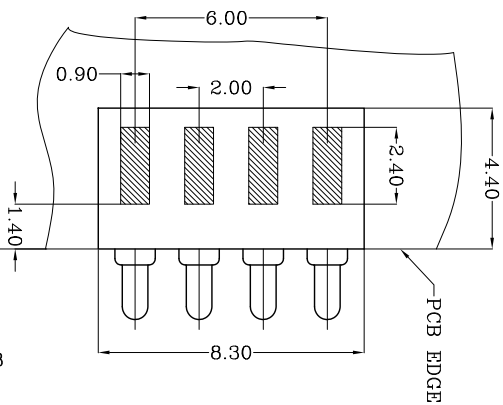


DWG NO.
C-100049

TOP-LINK

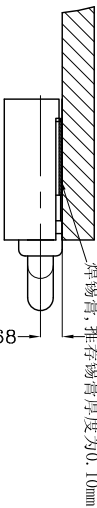


Application status 1

IMPURANT: The recommended thickness of solder paste is 0.10mm

焊锡膏, 推荐锡膏厚度为0.10mm

0.68



Application status 2 0

Notes:

Material(材质):
Housing: LCP Color Black.
Contact: Brass
Spring : Stainless steel wire

2 Plating:

1)Body: Min 0.1um Gold plating over min. 1.4um Nickel plating
(Body: 镀金0.1um Min 镀底1.4um Min)
2)Plunger: Min 0.4um Gold plating over min. 1.4um Nickel plating
(Plunger: 镀金0.4um Min 镀底1.4um Min)

3 Mechanical:

Spring force: Min 0.2N with 0.3mm stroke
1.1 +0.30N/-0.20N with 1.0mm stroke.

Total stroke(总行程): 1.40mm
Durability(寿命): 10,000 cycle min.

	变更材质		2010/05/12
	更改材料		2010/01/26
LTR	REVISION RECORD	APVD	DATE

DIMENSIONS IN MM TOLERANCES UNLESS OTHER SPECIFIED 0 = ±- 0.0 = ±0.10 0.00 = ±- 0.000 = ±				MATL △1				HT TR —		FIN — ✓	
ANGLE: ±1°				DWN QIN		APVD		Top-Link Electronics Ltd.			
SURF TEXTURE: 3.2/ REMOVE BURS, BREAK SHARP EDGES R0.05 MAX DO NOT SCALE PRINT				CHK		REL		Electronics			

NAME BATTERY POGO CONNECTOR 4 POSITIONS RIGHT ANGLE PGC-1.36-6.6-RA-4P-2.OPH								
SCALE	1:1	A4	DWG NO.	C-100049	SHEET	1 OF 1	REV	E

100049-4

PART NUMBER